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INFORMATION DISCLOSURE STATEMENT BY APPLICANT				Application Number	10/788,689
(use as many sheets as necessary)				Filing Date	
				First Named Inventor	Chuan-De Huang
				Art Unit	2875
				Examiner Name	Mark Tsidulkko
Sheet	1	of	1	Attorney Docket Number	N/A

U.S. PATENT DOCUMENTS

FOREIGN PATENT DOCUMENTS

Examiner Initials	Cite No. ¹	Foreign Patent Document	Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear	T
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